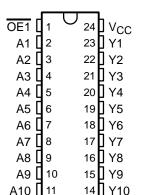
SCBS478 - MAY 1993 - REVISED NOVEMBER 1993

- State-of-the-Art BiCMOS Design Significantly Reduces I_{CCZ}
- ESD Protection Exceeds 2000 V Per MIL-STD-883C, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- High-Impedance State During Power Up and Power Down
- 3-State Outputs Drive Bus Lines or Buffer-Memory Address Registers
- P-N-P Inputs Reduce DC Loading
- Flow-Through Architecture Optimizes PCB Layout
- Package Options Include Plastic Small-Outline (DW) Packages and Standard Plastic 300-mil DIPs (NT)



GND [

12

13 OE2

DW OR NT PACKAGE

(TOP VIEW)

description

This 10-bit buffer/driver provides high-performance bus interface for wide data paths or buses carrying parity.

The 3-state control gate is a 2-input AND gate with active-low inputs so that if either output-enable ($\overline{OE1}$ or $\overline{OE2}$) input is high, all ten outputs are in the high-impedance state. The outputs are also in the high-impedance state during power-up and power-down conditions. The outputs remain in the high-impedance state while the device is powered down.

The SN64BCT29828B is characterized for operation from -40°C to 85°C and 0°C to 70°C.

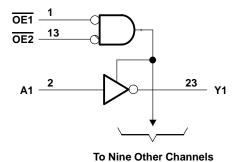
FUNCTION TABLE

	INPUTS	ОИТРИТ			
OE1	OE2	Α	Y		
L	L	L	Н		
L	L	Н	L		
Н	X	Χ	Z		
Х	Н	Χ	Z		

logic symbol†

ΕN 13 OE2 23 **Y**1 Α1 22 **A2 Y2** 4 21 **Y3 A3** 5 20 Α4 **Y4** 6 19 Α5 **Y5** 7 18 **Y6** A6 8 17 **Y7 A7** 16 9 **8**A **Y8** 10 15 Y9 Α9 11 14 Y10 A10

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, V _{CC}	
Input voltage range, V _I (see Note 1)	
Voltage range applied to any output in the disabled or power-off state, $V_{\mbox{\scriptsize O}}$	$\dots \dots -0.5~V$ to 5.5 V
Voltage range applied to any output in the high state, V _O	$\dots \dots -0.5 \text{ V to } 5.5 \text{ V}$
Input clamp current, I _{IK} (V _I < 0)	30 mA
Current into any output in the low state, I _O	96 mA
Operating free-air temperature range	40°C to 85°C
Storage temperature range	65°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

recommended operating conditions (see Note 2)

		MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	V
V _{IH}	High-level input voltage	2			V
V _{IL}	Low-level input voltage			8.0	V
lik	Input clamp current			-18	mA
ІОН	High-level output current			-24	mA
l _{OL}	Low-level output current			48	mA
TA	Operating free-air temperature	-40		85	°C

NOTE 2: Unused or floating inputs must be held high or low.



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS			MIN	TYP [†]	MAX	UNIT
VIK	$V_{CC} = 4.5 \text{ V},$	$I_{\parallel} = -18 \text{ mA}$				-1.2	V
	V _{CC} = 4.5 V	$I_{OH} = -15 \text{ mA}$		2.4	3.3		
Voн	VCC = 4.5 V	$I_{OH} = -24 \text{ mA}$	I _{OH} = – 24 mA				V
	V _{CC} = 4.75 V,	$I_{OH} = -3 \text{ mA}$	$I_{OH} = -3 \text{ mA}$				
V _{OL}	$V_{CC} = 4.5 V,$	I _{OL} = 48 mA			0.42	0.5	٧
loz	V _{CC} = 0 to 2.3 V (power up)	V _O = 2.7 V or 0.5 V,	OE at 0.8 V			±50	μΑ
loz	V _{CC} = 1.8 V to 0 (power down)	VO = 2.7 V 01 0.5 V,	OE at 0.6 v			±50	μΑ
lozh	V _{CC} = 5.5 V,	V _O = 2.7 V				20	μΑ
lozL	V _{CC} = 5.5 V,	$V_0 = 0.5 V$				-20	μΑ
lį	V _{CC} = 5.5 V,	V _I = 7 V				0.1	mA
lН	V _{CC} = 5.5 V,	V _I = 2.7 V				20	μΑ
I _{IL}	V _{CC} = 5.5 V,	V _I = 0.5 V				-0.2	mA
los [‡]	$V_{CC} = 5.5 \text{ V},$	V _O = 0		-75		-250	mA
ICCL	V _{CC} = 5.5 V,	Outputs open			28	40	mA
Іссн	V _{CC} = 5.5 V,	Outputs open			15	25	mA
ICCZ	V _{CC} = 5.5 V,	Outputs open	•		3.5	6	mA
C _i	V _{CC} = 5 V,	V _I = 2.5 V to 0.5 V			4.5		pF
Co	V _{CC} = 5 V,	$V_0 = 2.5 \text{ V to } 0.5 \text{ V}$	·		7		pF

switching characteristics over recommended range of supply voltage, C_L = 50 pF (unless otherwise noted) (see Note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 5 V, T _A = 25°C		T _A = -40°C to 85°C		T _A = 0°C to 70°C		UNIT		
	(INFOI)		MIN	TYP	MAX	MIN	MAX	MIN	MAX]	
tPLH	A	٨	Y	1	3.3	5.2	1	6.3	1	5.9	
t _{PHL}		Ť	1	5.1	4.2	1	4.9	1	4.5	ns	
^t PZH	ŌĒ	OE Y	2	5.3	7.7	2	9.2	2	8.6		
t _{PZL}			2	8.5	10.2	2	12.7	2	11.9	ns	
^t PHZ	ŌĒ	Y	2	5.4	7.6	2	9.4	2	8.7		
tPLZ		T T	2	5.1	6.8	2	9	2	8.1	ns	

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



[†] All typical values are at V_{CC} = 5 V, T_A = 25°C. ‡ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

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